

25 MIPS, 32 kB Flash, 10-Bit ADC, 32-Pin Mixed-Signal MCU

Analog Peripherals

10-Bit ADC

- ±1 LSB INL; no missing codes
- Programmable throughput up to 100 ksps
- 4 external inputs; programmable as single-ended or differential
- Programmable amplifier gain: 16, 8, 4, 2, 1, 0.5
- Data-dependent windowed interrupt generator
- Built-in temperature sensor (±3 °C)

Two 12-Bit DACs

- Voltage output
- 10 µsec settling time

Comparator

- 16 programmable hysteresis values
- Configurable to generate interrupts or reset

Internal Voltage Reference

V_{DD} Monitor/Brown-out Detector

On-Chip JTAG Debug

- On-chip emulation circuitry facilitates full-speed, non-intrusive, in-circuit emulation
- Supports breakpoints, single stepping, watchpoints, inspect/modify memory, and registers
- Superior performance to emulation systems using ICE-chips, target pods, and sockets
- Fully compliant with IEEE 1149.1 specification

High-Speed 8051 µC Core

- Pipelined instruction architecture; executes 70% of Instructions in 1 or 2 system clocks
- Up to 25 MIPS throughput with 25 MHz clock
- Expanded interrupt handler; up to 21 interrupt sources

Memory

- 2304 bytes data RAM
- 32 kB Flash; in-system programmable in 512-byte sectors (512 bytes are reserved)

Digital Peripherals

- 8 port I/O; all are 5 V tolerant
- Hardware SMBus™ (I2C™ compatible), SPI™, and UART serial ports available concurrently
- Programmable 16-bit counter/timer array with five capture/compare modules
- 4 general-purpose 16-bit counter/timers
- Dedicated watchdog timer; bidirectional reset

Clock Sources

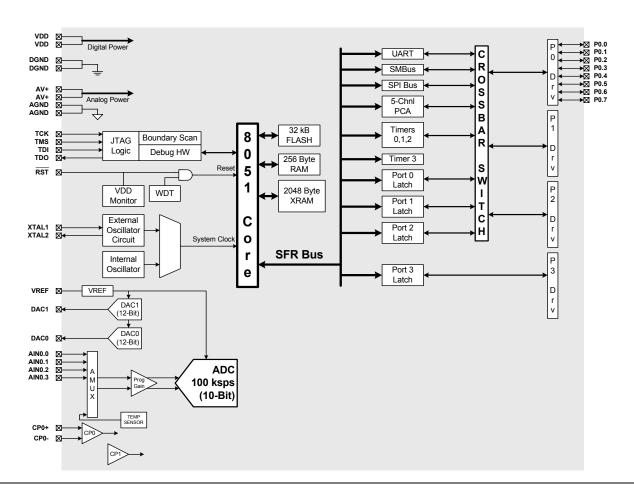
- Internal programmable oscillator: 2-16 MHz
- External oscillator: Crystal, RC, C, or Clock
- Can switch between clock sources on-the-fly

Supply Voltage: 2.7 to 3.6 V

- Typical operating current: 12.5 mA at 25 MHz
- Multiple power saving sleep and shutdown modes

32-Pin LQFP

Temperature Range: -40 to +85 °C



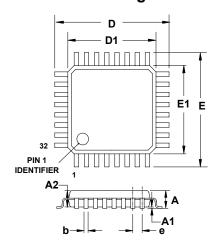
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Selected Electrical Specifications

 $(T_A = -40 \text{ to } +85 \text{ C}^\circ, V_{DD} = 2.7 \text{ V} \text{ unless otherwise specified})$

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS	
GLOBAL CHARACTERISTICS						
Analog Supply Voltage		2.7		3.6	V	
Analog Supply Current	Internal REF, ADC, DAC, Comparators all active		0.8		mA	
Analog Supply Current with	Internal REF, ADC, DAC, Comparators all		5		μA	
analog sub-systems inactive	disabled					
Digital Supply Voltage		2.7		3.6	V	
Digital Supply Current with	Clock = 25 MHz		12		mA	
CPU active	Clock = 1 MHz		0.5		mA	
	Clock = 32 kHz		20		μA	
Digital Supply Current (shutdown mode)	Oscillator not running		2		μΑ	
V _{DD} Data Retention Voltage	RAM remains valid		1.5		V	
CPU & DIGITAL I/O				•		
Clock Frequency Range		DC		25	MHz	
Port Output High Voltage	I _{OH} = -3 mA, Port I/O push-pull	$V_{DD} - 0.7$			V	
Port Output Low Voltage	I _{OL} = 8.5 mA			0.6	V	
Input High Voltage		0.8 x V _{DD}			V	
Input Low Voltage				0.2 x V _{DD}	V	
SMBus SCL Frequency	SYSCLK = MCU system clock			SYSCLK/8	MHz	
SPI Bus Clock Frequency	SYSCLK = MCU system clock			SYSCLK/2	MHz	
A/D CONVERTER						
Resolution		10			bits	
Integral Nonlinearity				±1	LSB	
Differential Nonlinearity	Guaranteed Monotonic			±1	LSB	
Throughput Rate				100	ksps	
Input Voltage Range		0		V _{REF}	V	
D/A CONVERTERS						
Resolution		12			bits	
Integral Nonlinearity	Specified from Data Word 014h to FEBh		±4		LSB	
Differential Nonlinearity	Guaranteed Monotonic			±1	LSB	
Offset Error	Data Word = 014h		±3		LSB	
Output Settling Time	To ½ LSB of full-scale		10		μs	
Output Voltage Swing		0		V _{REF} – 1 LSB	V	
COMPARATOR						
Supply Current			1.5		μA	
Response Time	(CP+) - (CP-) = 100 mV		4		μs	
Input Voltage Range		-0.25		(AV+) +0.25	V	
Input Bias Current		-5	0.001	+5	nA	
Input Offset Voltage		-10		+10	mV	

Package Information



			MAX
_	(mm)	(mm)	(mm)
A	-	-	1.60
A1	0.05	-	0.15
A2	1.35	1.40	1.45
b	0.30	0.37	0.45
D	-	9.00	-
D1	-	7.00	-
е	-	0.80	-
E	-	9.00	-
E1	-	7.00	-

C8051F005DK Development Kit

